

## Diode

Silicon Carbide Schottky Diode

# IDH02G120C5

5<sup>th</sup> Generation CoolSiC<sup>™</sup> 1200 V SiC Schottky Diode

## **Final Datasheet**

Rev. 2.1 2017-07-21

# Industrial Power Control

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5<sup>th</sup> Generation CoolSiC<sup>™</sup> 1200 V SiC Schottky Diode

1

## CoolSiC<sup>™</sup> SiC Schottky Diode

#### Features:

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Qualified according to JEDEC<sup>1)</sup> for target applications
- Pb-free lead plating; RoHS compliant

#### **Benefits**

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size / cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- RelatedLinks: <u>www.infineon.com/sic</u>

#### **Applications**

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- Power Factor Correction

#### Package pin definitions

- Pin 1 and backside cathode
- Pin 2 anode

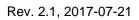


#### Key Performance and Package Parameters

Туре	V <sub>DC</sub>	l <sub>F</sub>	Q <sub>c</sub>	<b>T</b> <sub>j,max</sub>	Marking	Package
IDH02G120C5	1200V	2A	14nC	175°C	D0212C5	PG-TO220-2-1

1) J-STD20 and JESD22

Final Data Sheet







#### **Table of Contents**

Description	2
Table of Contents	3
Maximum Ratings	4
Thermal Resistances	4
Electrical Characterics	5
Electrical Characteristics Diagram	6
Package Drawings	9
Revision History	10
Disclaimer	11



#### **Maximum ratings**

Parameter	Symbol	Value	Unit	
Repetitive peak reverse voltage	V <sub>RRM</sub>	1200	V	
Continues forward current for $R_{th(j-c,max)}$ $T_c = 168^{\circ}C, D=1$ $T_c = 135^{\circ}C, D=1$ $T_c = 25^{\circ}C, D=1$	IF	2 5.7 11.8	A	
Surge non-repetitive forward current, sine halfwave $T_c=25^{\circ}C$ , $t_p=10ms$ $T_c=150^{\circ}C$ , $t_p=10ms$	I <sub>F,SM</sub>	37 31	A	
Non-repetitive peak forward current $T_{\rm C} = 25^{\circ}{\rm C}, t_{\rm p}=10 \ \mu{\rm s}$	I <sub>F,max</sub>	344	А	
<sup>i2</sup> t value $T_{\rm C} = 25^{\circ}{\rm C}, t_{\rm p} = 10 \text{ ms}$ $T_{\rm C} = 150^{\circ}{\rm C}, t_{\rm p} = 10 \text{ ms}$	∫ i²dt	7 4.9	A²s	
Diode dv/dt ruggedness V <sub>R</sub> =0960V	dv/dt	80	V/ns	
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	P <sub>tot</sub>	75	W	
Operating and storage temperature	$T_{\rm j}$ ; $T_{\rm stg}$	-55175	°C	
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	T <sub>sold</sub>	260	°C	
Mounting torque M3 and M4 screws	М	0.7	Nm	

#### **Thermal Resistances**

Parameter	Symbol	Conditions min.		Value	Unit	
Falameter	Symbol		min.	typ.	max.	Unit
Characteristic						
Diode thermal resistance, junction – case	R <sub>th(j-c)</sub>		-	1.54	2	K/W
Thermal resistance, junction – ambient	R <sub>th(j-a)</sub>	leaded	-	-	62	K/W



#### **Electrical Characterics**

#### Static Characteristics, at T<sub>j</sub>=25°C, unless otherwise specified

Parameter	Symbol	Conditions min.		Value	Unit	
Falameter			min.	typ.	max.	Onit
Static Characteristic						
DC blocking voltage	V <sub>DC</sub>	$T_{\rm j} = 25^{\circ}{\rm C}$	1200	-	-	V
Diode forward voltage	V <sub>F</sub>	$I_{\rm F}$ = 2A, $T_{\rm j}$ =25°C	-	1.4	1.65	V
Didde forward voltage		$I_{\rm F}$ = 2A, $T_{\rm j}$ =150°C	-	1.7	2.3	
Reverse current	1	V <sub>R</sub> =1200V, <i>T</i> <sub>j</sub> =25°C		1.2	18	μA
	I <sub>R</sub>	V <sub>R</sub> =1200V, <i>T</i> <sub>j</sub> =150°C		6	90	

#### Dynamic Characteristics, at $T_j=25$ °C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Farameter	Symbol		min.	typ.	max.	Onit
Dynamic Characteristics						
Total capacitive charge	Q <sub>c</sub>	$V_{\rm R}=800\rm V, \ T_{\rm j}=150\rm °C$ $Q_{\rm C}=\int_{0}^{V_{\rm R}}C(V)dV$	-	14	-	nC
Total Capacitance	С	V <sub>R</sub> =1 V, <i>f</i> =1 MHz V <sub>R</sub> =400 V, <i>f</i> =1 MHz V <sub>R</sub> =800 V, <i>f</i> =1 MHz		182 13 10		pF



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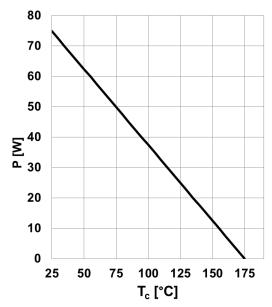


Figure 1. Power dissipation as a function of case temperature,  $P_{tot}=f(T_C)$ ,  $R_{th(j-c),max}$ 

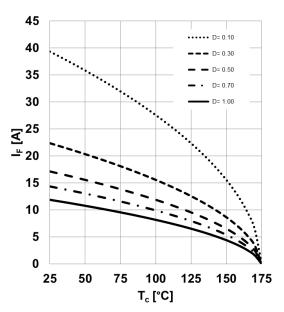
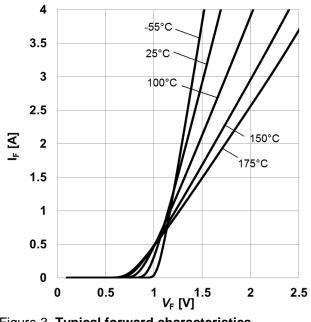
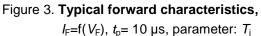


Figure 2. Diode forward current as function of temperature,  $T_j \le 175^{\circ}$ C,  $R_{th(j-c),max}$ , parameter D=duty cycle,  $V_{th}$ ,  $R_{diff}$  @  $T_j=175^{\circ}$ C





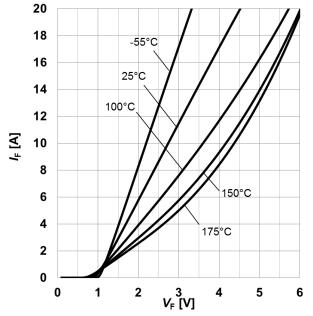


Figure 4. Typical forward characteristics in surge current,  $I_F=f(V_F)$ ,  $t_p=10 \ \mu s$ , parameter:  $T_i$ 



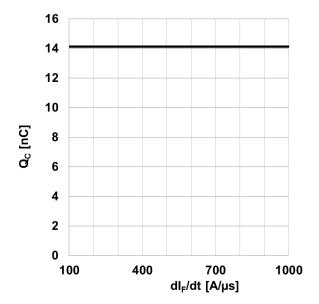


Figure 5. Typical capacitive charge as function of current slope<sup>1</sup>,  $Q_C=f(dI_F/dt)$ ,  $T_j=150$ °C 1) Only capacitive charge, guaranteed by design.

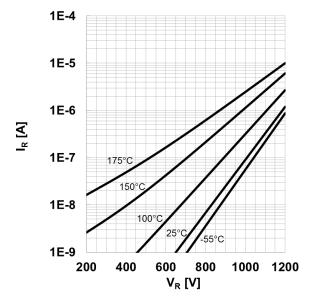
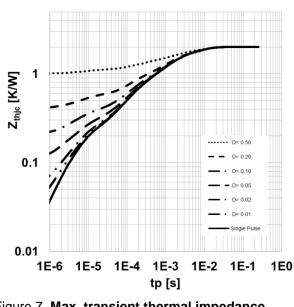
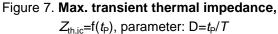


Figure 6. Typical reverse current as function of reverse voltage,  $I_R=f(V_R)$ , parameter:  $T_i$ 





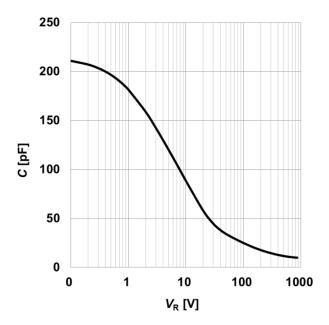


Figure 8. Typical capacitance as function of reverse voltage,  $C=f(V_R)$ ;  $T_i=25^{\circ}C$ ; f=1 MHz



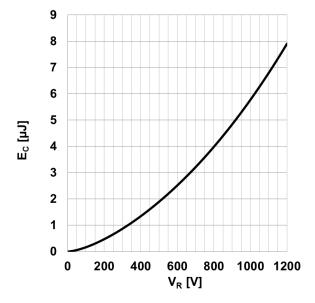


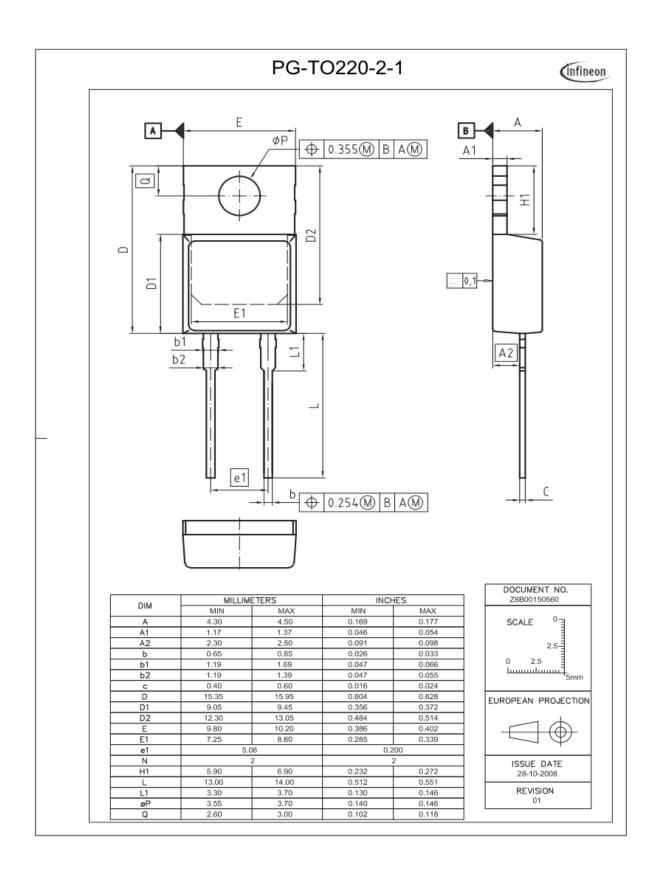
Figure 9. Typical capacitively stored energy as function of reverse voltage,

$$E_C = \int_0^{V_R} C(V) V dV$$



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#### **Revision History**

IDH02G120C5

#### Revision:2017-07-12, Rev. 2.1

Previous Revision:					
Revision	Date	Subjects (major changes since last version)			
2.0	2015-07-22 Final data sheet				
2.1	-	Editorial change			

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